

FEATURES

Broadband RF, LO, and IF ports Conversion gain: 3.7 dB Noise figure: 12.2 dB Input IP3: 22.7 dBm Input P1dB: 8.3 dBm LO drive: 0 dBm Differential high impedance RF input port Single-ended, 50 Ω LO input port Open-collector IF output port Single-supply operation: 5 V at 98 mA Power-down mode Exposed pad LFCSP: 3 mm × 3 mm

APPLICATIONS

Cellular base station receivers ISM receivers Radio links RF instrumentation

GENERAL DESCRIPTION

The [AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) is a high performance, broadband active mixer. It is well suited for demanding receive channel applications that require wide bandwidth on all ports and very low intermodulation distortion and noise figure.

The [AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) provides a typical conversion gain of 3.7 dB with an RF frequency of 238 MHz. The integrated LO driver presents a 50 Ω input impedance with a low LO drive level, helping to minimize the external component count.

The differential high impedance broadband RF port allows easy interfacing to both active devices and passive filters. The RF input accepts input signals as large as 1.6 V p-p or 8 dBm (relative to 50 Ω) at P1dB.

Active Receive Mixer Low Frequency to 3.8 GHz

Data Sheet **[AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf)**

FUNCTIONAL BLOCK DIAGRAM

The open-collector differential outputs provide excellent balance and can be used with a differential filter or IF amplifier, such as the [AD8370,](http://www.analog.com/ad8370?doc=AD8342.pdf) [AD8375,](http://www.analog.com/AD8375?doc=AD8342.pdf) [AD8351,](http://www.analog.com/ad8351?doc=AD8342.pdf) [AD8352,](http://www.analog.com/ad8352?doc=AD8342.pdf) or [ADL5561.](http://www.analog.com/ADL5561?doc=AD8342.pdf) These outputs can also be converted to a single-ended signal using a matching network or a balun transformer. The outputs are capable of swinging 2 V p-p when biased to the VPOS supply rail.

The [AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) is fabricated on an Analog Devices, Inc., proprietary, high performance SiGe IC process. Th[e AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) is available in a 16-lead LFCSP. It operates over a −40°C to +85°C temperature range. An evaluation board is also available.

Rev. C [Document Feedback](https://form.analog.com/Form_Pages/feedback/documentfeedback.aspx?doc=AD8342.pdf&product=AD8342&rev=C)

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REVISION HISTORY

7/09—Rev. A to Rev. B

1/07—Rev. 0 to Rev. A

4/05—Revision 0: Initial Version

SPECIFICATIONS

 V_S = 5 V, T_A = 25°C, f_{RF} = 238 MHz, f_{LO} = 286 MHz, LO power = 0 dBm, Z_O = 50 Ω, R_{BIAS} = 1.82 kΩ, RF termination = 100 Ω, IF load = 100 Ω differential, unless otherwise noted.

Table 1.

AC PERFORMANCE

 V_S = 5 V, T_A = 25°C, LO power = 0 dBm, Z_O = 50 Ω, R_{BIAS} = 1.82 kΩ, RF termination 100 Ω, IF load = 100 Ω differential, unless otherwise noted.

¹ See th[e High Frequency Applications](#page-18-0) section for details.

² See th[e Low Frequency Applications](#page-20-0) section for details.

ABSOLUTE MAXIMUM RATINGS

Table 3.

¹ Measured using a JESD51-7 printed circuit board (PCB).

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

JUNCTION TO BOARD THERMAL IMPEDANCE

The junction to board thermal impedance (θ_{JB}) is the thermal impedance from the die to the leads of the [AD8342.](http://www.analog.com/AD8342?doc=AD8342.pdf) The value given i[n Table 3](#page-4-5) is based on the standard PCB described in JESD51-7 for the thermal testing of a surface-mount component. Board size and complexity (number of layers) affect θjΒ; more layers tend to reduce thermal impedance slightly.

If the board temperature is known, use the junction to board thermal impedance to calculate the die temperature (also known as the junction temperature) to ensure that it does not exceed the specified limit of 135°C. For example, if the board temperature is 85°C, the die temperature is given by the equation,

$$
T_{J} = T_{B} + \left(P_{DISS} \times \theta_{JB}\right)
$$

The worst case power dissipation for the [AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) is 593 mW $(5.25 \text{ V} \times 113 \text{ mA}, \text{see Table 1}).$ Therefore, T_1 is

 $T_{I} = 85^{\circ}\text{C} + (0.593 \text{ W} \times 37.4^{\circ}\text{C/W}) = 107.2^{\circ}\text{C}$

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

Figure 2. Pin Configuration

Table 4. Pin Function Descriptions

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05352-026

TYPICAL PERFORMANCE CHARACTERISTICS

 V_S = 5 V, T_A = 25°C, RF power = -10 dBm, LO power = 0 dBm, Z_O = 50 Ω, R_{BIAS} = 1.82 kΩ, RF termination 100 Ω, IF load = 100 Ω differential, unless otherwise noted.

Figure 5. Gain vs. Temperature, f_{RF} = 238 MHz, f_{LO} = 286 MHz Figure 8. Conversion Gain Distribution, $f_{RF} = 238$ MHz, $f_{LO} = 286$ MHz

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05352-031

Figure 17. Input P1dB vs. Temperature, $f_{RF} = 238$ MHz, $f_{LO} = 286$ MHz

Figure 21. Input IP2 vs. RF Frequency (Second RF = RF − 50 MHz)

Figure 24. Input IP2 vs. IF Frequency (Second RF = RF − 50 MHz)

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Figure 29. Input IP2 vs. R_{BIAS}, f_{RF} = 238 MHz (Second RF = RF - 50 MHz), $f_{LO} = 286$ MHz

Figure 30. Noise Figure Distribution, $f_{RF} = 238$ MHz, $f_{LO} = 286$ MHz

Figure 31. Noise Figure, Input IP3, and Supply Current vs. RBIAS, $f_{RF1} = 238$ MHz, $f_{RF2} = 239$ MHz, $f_{LO} = 286$ MHz

Figure 32. Input P1dB vs. R_{BIAS} , $f_{RF} = 238$ MHz, $f_{LO} = 286$ MHz

Figure 33. LO to RF Leakage vs. LO Frequency, LO Power = 0 dBm

Figure 35. LO to IF Feedthrough vs. LO Frequency, LO Power = 0 dBm

SPURIOUS PERFORMANCE

Nf_{RF} – Mf_{LO} spur measurements were taken using the standard test board. V_S = 5 V, T_A = 25°C, RF and LO power = 0 dBm, f_{RF} = 238 MHz, f_{LO} = 286 MHz, Z_O = 50 Ω, R_{BIAS} = 1.82 kΩ, RF termination 100 Ω, IF load = 100 Ω differential.

Typical noise floor of measurement system = −100 dBm.

Table 5.

TEST CIRCUIT

Figure 38. Characterization Circuit Used to Measure Typical Performance Characteristics Data

THEORY OF OPERATION

The [AD8342 i](http://www.analog.com/AD8342?doc=AD8342.pdf)s an active mixer, optimized for operation within the RF input frequency range of near dc to 3.8 GHz. It has a differential, high impedance RF input that can be terminated or matched externally. The RF input can be driven either single-ended or differentially. The LO input is a single-ended 50 Ω input. The IF outputs are differential open-collectors. The mixer current can be adjusted by the value of an external resistor to optimize performance for gain, compression, and intermodulation, or for low power operation[. Figure 39 s](#page-14-1)hows the basic blocks of the mixer, including the LO buffer, RF voltage-to-current converter, bias cell, and mixing core.

The RF voltage to RF current conversion is done via a resistively degenerated differential pair. To drive this port single-ended, the RFCM pin must be ac grounded and the RFIN pin ac-coupled to the signal source. The RF inputs can also be driven differentially. The voltage to current converter then drives the emitters of a four-transistor switching core. This switching core is driven by an amplified version of the local oscillator signal connected to the LO input. There are three limiting gain stages between the external LO signal and the switching core. The first stage converts the single-ended LO drive to a well-balanced differential drive. The differential drive then passes through two more gain stages, which ensures that a limited signal drives the switching core. This affords the user a lower LO drive requirement, while maintaining excellent distortion and compression performance. The output signal of these three LO gain stages drives the four transistors within the mixer core to commutate at the rate of the local oscillator frequency. The output of the mixer core is taken directly from its open-collectors. The open-collector outputs present a high impedance at the IF frequency. The conversion gain of the mixer depends directly on the impedance presented to these open-collectors. In characterization, a 100 Ω load was presented to the device via a 2:1 impedance transformer.

The device also features a power-down function. Application of a logic low at the PWDN pin allows normal operation. A high logic level at the PWDN pin shuts down the [AD8342.](http://www.analog.com/AD8342?doc=AD8342.pdf) Power consumption when the device is disabled is less than 10 mW.

The bias for the mixer is set with an external resistor (RBIAS) from the EXRB pin to ground. The value of this resistor directly affects the dynamic range of the mixer. The external resistor must not be lower than 1.82 kΩ. Permanent damage to the

device can result if values below 1.8 kΩ are used. This resistor sets the dc current through the mixer core. The performance effects of changing this resistor can be seen in the [Typical](#page-6-0) [Performance Characteristics s](#page-6-0)ection.

Figure 39. Simplified Schematic Showing the Key Elements of th[e AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf)

As shown in [Figure 40,](#page-14-2) the IF output pins, IFOP and IFOM, are directly connected to the open-collectors of the NPN transistors in the mixer core so the differential and single-ended impedances looking into this port are relatively high, on the order of several kΩ. A connection between the supply voltage and these output pins is required for proper mixer core operation.

The [AD8342 h](http://www.analog.com/AD8342?doc=AD8342.pdf)as three pins for the supply voltage: VPDC, VPMX, and VPLO. These pins are separated to minimize or eliminate possible parasitic coupling paths within th[e AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) that can cause spurious signals or reduced interport isolation. Consequently, each of these pins must be well bypassed and decoupled as close to the [AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) as possible.

AC INTERFACES

The [AD8342 i](http://www.analog.com/AD8342?doc=AD8342.pdf)s designed to downconvert radio frequencies (RF) to lower intermediate frequencies (IF) using a high- or low-side local oscillator (LO). The LO is injected into the mixer core at a frequency higher or lower than the desired input RF. The frequency difference between the LO and the RF, $f_{LO} - f_{RF}$ (high side) or $f_{RF} - f_{LO}$ (low side), is the intermediate frequency, f_{IF} . In addition to the desired RF signal, an RF image is downconverted to the desired IF frequency. The image frequency is at $f_{LO} + f_{IF}$ when driven with a high-side LO. When using a broadband load, the conversion gain of the [AD8342 i](http://www.analog.com/AD8342?doc=AD8342.pdf)s nearly constant over the specified RF input band (see [Figure 3\)](#page-6-1).

The [AD8342 i](http://www.analog.com/AD8342?doc=AD8342.pdf)s designed to operate over a broad frequency range. It is essential to ac couple RF and LO ports to prevent dc offsets from skewing the mixer core in an asymmetrical manner, potentially degrading noise figure and linearity.

The RF input of th[e AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) is high impedance, 1 k Ω across the frequency range shown i[n Figure 41.](#page-15-1) The input capacitance decreases with frequency due to package parasitics.

The matching or termination used at the RF input of th[e AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) has a direct effect on its dynamic range. The characterization circuit, as well as the evaluation board, uses a 100 Ω resistor to terminate the RF port. This termination resistor in shunt with the input stage results in a return loss of better than −10 dBm (relative to 50 Ω)[. Table 6 s](#page-15-2)hows gain, IP3, P1dB, and noise figure (NF) for four different input networks. This data was measured at an RF frequency of 250 MHz and at an LO frequency of 300 MHz.

The RF port can also be matched using an LC circuit, as shown in [Figure 42.](#page-15-3)

Impedance transformations of greater than 10:1 result in a higher Q circuit and thus a narrow RF input bandwidth. A 1 kΩ resistor is placed across the RF input of the device in parallel with the device internal input impedance, creating a 500 Ω load. This impedance is matched to as close as possible to 50 Ω for the source, with standard components using a shunt C, series L matching circuit (se[e Figure 43\)](#page-15-4).

Figure 43. LC Matching Example

IF PORT

The IF port comprises open-collector differential outputs. The NPN open-collectors can be modeled as current sources that are shunted with resistances of ~10 kΩ in parallel with capacitances of ~1 pF.

The specified performance numbers for the [AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) were measured with 100 $Ω$ differential terminations. However, different load impedances can be used where circumstances dictate. In general, lower load impedances result in lower conversion gain and lower output P1dB. Higher load impedances result in higher conversion gain for small signals, but lower IP3 values for both input and output.

If the IF signal is to be delivered to a remote load, more than a few millimeters away at high output frequencies, avoid unintended parasitic effects due to the intervening PCB traces. One approach is to use an impedance transforming network or transformer located close to th[e AD8342.](http://www.analog.com/AD8342?doc=AD8342.pdf) If very wideband output is desired, a nearby buffer amplifier may be a better choice, especially if IF response to dc is required. An example of such a circuit is presented in [Figure 45,](#page-16-1) in which th[e AD8351](http://www.analog.com/ad8351?doc=AD8342.pdf) differential amplifier is used to drive a pair of 75 Ω transmission lines. The gain of the buffer can be independently set by appropriate choice of the value for the gain resistor, RG.

Figure 45[. AD8351](http://www.analog.com/ad8351?doc=AD8342.pdf) Used as Transmission Line Driver and Impedance Buffer

The high input impedance of th[e AD8351](http://www.analog.com/ad8351?doc=AD8342.pdf) allows a shunt differential termination to provide the desired 100 Ω load to the [AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) IF output port.

It is necessary to bias the open-collector outputs using one of the schemes presented in [Figure 47](#page-17-1) an[d Figure 48.](#page-17-2) [Figure 47](#page-17-1) illustrates the application of a center-tapped impedance transformer. The turn ratio of the transformer must be selected to provide the desired impedance transformation. In the case of a 50 Ω load impedance, use a 2-to-1 impedance ratio transformer to transform the 50 Ω load into a 100 Ω differential load at the IF output pins[. Figure 48](#page-17-2) illustrates a differential IF interface where pull-up choke inductors are used to bias the open-collector outputs. The shunting impedance of the choke inductors used to couple dc current into the mixer core must be large enough at the IF operating frequency so it does not load down the output current before reaching the intended load. Additionally, the dc current handling capability of the selected choke inductors must be at least 45 mA. The self-resonant frequency of the selected choke must be higher than the intended IF frequency. A variety of suitable choke inductors is commercially available from manufacturers such as Murata and Coilcraft®[. Figure 46](#page-16-2) shows the loading effects when using nonideal inductors. An impedance transforming network may be required to transform the final load impedance to 100 Ω at the IF outputs. There are several good reference books that explain general impedance matching procedures, including:

- Chris Bowick, *RF Circuit Design*, Newnes, Reprint Edition, 1997.
- David M. Pozar, *Microwave Engineering*, Wiley, Third Edition, 2004.
- Guillermo Gonzalez, *Microwave Transistor Amplifiers: Analysis and Design*, Prentice Hall, Second Edition, 1996.

Figure 46. IF Port Loading Effects Due to Finite Q Pull-Up Inductors (Murata BLM18HD601SN1D Chokes)

Figure 48. Biasing the IF Port Open-Collector Outputs Using Pull-Up Choke Inductors

The [AD8342 i](http://www.analog.com/AD8342?doc=AD8342.pdf)s optimized for driving a 100 Ω load. Although the device is capable of driving a wide variety of loads, to maintain optimum distortion and noise performance, it is advised that the presented load at the IF outputs is close to 100 Ω. The linear differential voltage conversion gain of the mixer can be modeled as

 $Av = G_m \times R_{LOAD}$

where:

$$
G_m = \frac{1}{\pi} \times \frac{g_m}{1 + g_m R_e}
$$

RLOAD is the single-ended load impedance.

 g_m is the transistor transconductance and is equal to $1810/R_{BIAS}$. $R_e = 15 \Omega$.

The external R_{BIAS} resistor controls the power dissipation and dynamic range of th[e AD8342.](http://www.analog.com/AD8342?doc=AD8342.pdf) Because th[e AD8342 h](http://www.analog.com/AD8342?doc=AD8342.pdf)as internal resistive degeneration, the conversion gain is primarily determined by the load impedance and the on-chip degeneration resistors. [Figure 49 s](#page-17-3)hows how gain varies with IF load. The external RBIAS resistor has only a small effect. The most direct way to affect conversion gain is by varying the load impedance. Small loads result in lower gains while larger loads increase the conversion gain. If the IF load impedance is too large, it causes a decrease in linearity (P1dB, IP3). To maintain positive conversion gain and preserve SFDR performance, the differential load presented at the IF port must remain in the range of about 100 Ω to 250 Ω .

LO CONSIDERATIONS

The LOIN port provides a 50 Ω load impedance with commonmode decoupling on LOCM. Again, common-grade ceramic capacitors provide sufficient signal coupling and bypassing of the LO interface.

The LO signal must have adequate phase noise characteristics and low second harmonic content to prevent degradation of the noise figure performance of th[e AD8342.](http://www.analog.com/AD8342?doc=AD8342.pdf) An LO plagued with poor phase noise can result in reciprocal mixing, a mechanism that causes spectral spreading of the downconverted signal, limiting the sensitivity of the mixer at frequencies adjacent to any large input signals. The internal LO buffer provides enough gain to hard-limit the input LO and provide fast switching of the mixer core. Odd harmonic content present on the LO drive signal does not impact mixer performance; however, even-order harmonics cause the mixer core to commutate in an unbalanced manner, potentially degrading noise performance. Simple lumped element low-pass filtering can be applied to help reject the harmonic content of a given local oscillator, as shown i[n Figure 50.](#page-17-4) The filter depicted is a common 3-pole Chebyshev, designed to maintain a 1-to-1 source-to-load impedance ratio with no more than 0.5 dB of ripple in the pass band. Other filter structures can be effective as long as the second harmonic of the LO is filtered to negligible levels, for example, ~30 dB below the fundamental.

Figure 50. Using a Low-Pass Filter to Reduce LO Second Harmonic

The [AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) is a broadband mixer capable of both up and down conversion. Unlike other mixers that rely on on-chip reactive circuitry to optimize performance over a specific band, the [AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) is a versatile general-purpose device that can be used from arbitrarily low frequencies to several GHz. In general, the following considerations help ensure optimum performance:

- Minimize the ac loading impedance of IF port bias network.
- Maximize the power transfer to the desired ac load.
- For the maximum conversion gain and the lowest noise performance, reactively match the input as described in the [IF Port](#page-16-0) section.
- For the maximum input compression point and input intercept points, resistively terminate the input as described in the [IF Port](#page-16-0) section.

As an example[, Figure 51](#page-18-1) shows th[e AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) as an upconverting mixer for a W-CDMA single-carrier transmitter design. For this application, it was desirable to achieve −65 dBc adjacent channel power ratio (ACPR) at a −13 dBm output power level. The ACPR is a measure of both distortion and noise carried into an adjacent frequency channel due to the finite intercept points and noise figure of an active device.

Figure 51. W-CDMA Tx Upconversion Application Circuit

Because a W-CDMA channel encompasses a bandwidth of almost 5 MHz, it is necessary to keep the Q of the matching circuit low enough so that phase and magnitude variations are below an acceptable level over the 5 MHz band. It is possible to use purely reactive matching to transform a 50 Ω source to match the raw ~1 k Ω input impedance of the [AD8342.](http://www.analog.com/AD8342?doc=AD8342.pdf) However, the L and C component variations can present production concerns due to the sensitivity of the match. For this application, it is advantageous to reduce the ~1 k Ω input impedance using an external shunt termination resistor to allow a lower Q reactive

matching network. In [Figure 52,](#page-18-2) the input is terminated across the RFIN and RFCM pins using a 499 Ω termination. The termination must be as close to the device as possible to minimize standing wave concerns. The RFCM is bypassed to ground using a 1 nF capacitor. A dc blocking capacitor of 1 nF is used to isolate the dc input voltage present on the RFIN pin from the source. A step-up impedance transformation is realized using a series L shunt C reactive network. The actual values used must accommodate for the series L and stray C parasitics of the connecting transmission line segments. When using the customer evaluation board with the components specified i[n Figure 51,](#page-18-1) the return loss over a 5 MHz band centered at 170 MHz was better than 10 dB.

External pull-up choke inductors feed dc bias into the opencollector outputs. It is desirable to select pull-up choke inductors that present high loading reactance at the output frequency. Coilcraft 0302CS series inductors were selected due to their very high self resonant frequency and Q. A 1:1 balun was ac-coupled to the output to convert the differential output to a single-ended signal and present the output with a 50 Ω ac loading impedance.

The performance of the circuit is shown i[n Figure 52.](#page-18-2) The average ACPR of the adjacent and alternate channels is presented vs. output power. The circuit provides a 65 dBc ACPR at −13 dBm output power. The optimum ACPR power level can be shifted to the right or left by adjusting the output loading and the loss of the input match.

Figure 52. Single Carrier W-CDMA ACPR Performance of Tx Upconversion Circuit (Test Model 1_64)

The available frequency range of th[e AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) is extremely broad. With adequate care, any of the mixer ports can be optimized for extremely low frequencies, or up to several GHz. The standard evaluation board is populated for broadband performance from a few MHz to ~1 GHz. The input match of the RF port degrades at higher frequencies when using the standard eval board. The broadband frequency range can be extended by minimizing parasitics between the input terminating resistor, R5, and the input pins.

Figure 53. Modified Evaluation Board Schematic for Broadband Downconversion Performance up to 3 GHz

The measurements in [Figure 54 w](#page-19-1)ere made using the modified evaluation board as configured i[n Figure 53.](#page-19-2)

Figure 54. Input OIP3, Input P1dB, Gain, and NF vs. RF Frequency for a 190 MHz IF Using a Low-Side LO

The broadband frequency capabilities of the [AD8342 m](http://www.analog.com/AD8342?doc=AD8342.pdf)akes it an attractive solution for a variety of applications, including cellular, CATV, point-to-point radio links, and test equipment. As an example, the circuit depicted i[n Figure 53](#page-19-2) can easily be applied as a feedback mixer in a predistortion receiver design. The performance depicted i[n Figure 55](#page-19-3) was measured using a 160 MHz IF. Here, four W-CDMA carriers with high PAR are downconverted for IF sampling so that transmit path nonlinearities can be measured and minimized using digital predistortion techniques.

Figure 55. ACPR Performance for Multiple W-CDMA Carriers Being Downconverted from 2140 MHz to 160 MHz for Distortion Analysis

APPLICATIONS ABOVE 3 GHZ

Operation of th[e AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) mixer can be extended above 3 GHz; however, bandwidth is limited due to on-chip parasitics. By eliminating all unnecessary parasitics in the LO path, the LO input voltage standing wave ratio (VSWR) can be kept low up to 4 GHz[. Figure 56 s](#page-20-1)hows the circuit configuration for the RF input frequency of 3.5 GHz to 3.8 GHz. A 22 Ω resistor is added between the RFCM pin and the 1 nF capacitor to ground, and a 1 pF capacitor is also added to provide the tuning for the desired frequency range. The resulting RF and LO input return losses are shown i[n Figure 57.](#page-20-2) Using a fixed LO frequency of 3.4 GHz, the conversion gain response for the RF input frequency range from 3.5 GHz to 3.8 GHz is shown in [Figure 59.](#page-20-3)

Figure 58. RF and LO Return Loss with Matching

LOW FREQUENCY APPLICATIONS

The [AD8342](http://www.analog.com/AD8342?doc=AD8342.pdf) can be used in extremely low frequency applications. [Figure 59 d](#page-20-3)epicts the configuration with necessary modifications at IF ports. Two 10 Ω resistors bias the opencollector outputs and the output coupling capacitors must be large enough to allow intended low frequency operation[. Figure 60](#page-20-4) illustrates the gain performance at fixed IF of 10 kHz and 1 MHz for broadband downconversion using a low-side LO.

Figure 59. Modified Evaluation Board Schematic for Downconverting Broadband RF to Low IF Frequencies

Figure 60. Gain Performance for 1 MHz and 10 kHz IF of Broadband Downconversion

EVALUATION BOARD

An evaluation board is available for th[e AD8342.](http://www.analog.com/AD8342?doc=AD8342.pdf) The evaluation board is configured for single-ended signaling at the IF output port via a balun transformer. The schematic for the evaluation board is presented i[n Figure 61.](#page-21-1) The representations of the board layout are included in [Figure 62 t](#page-22-0)hroug[h Figure 65.](#page-23-0)

Table 7. Evaluation Board Configuration Options

Figure 62. Evaluation Board Artwork Top

Figure 63. Evaluation Board Artwork Internal 1

Figure 64. Evaluation Board Artwork Internal 2

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Figure 65. Evaluation Board Artwork Bottom